



## Radiation Hardness Assurance testing challenge at TRAD

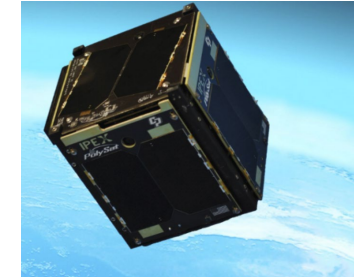
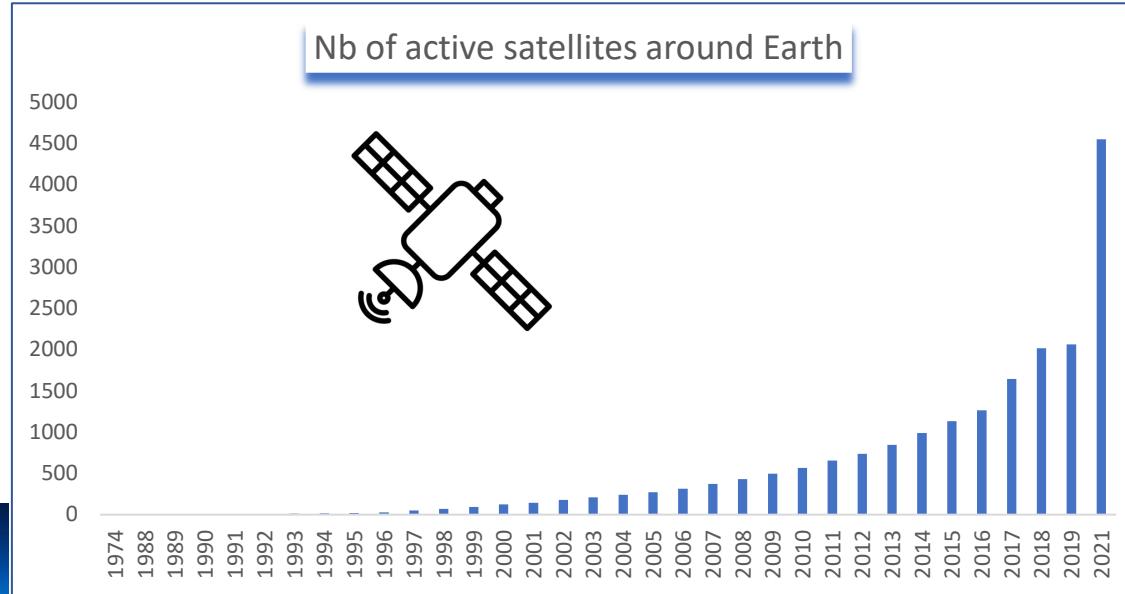
Presented by Pierre GARCIA



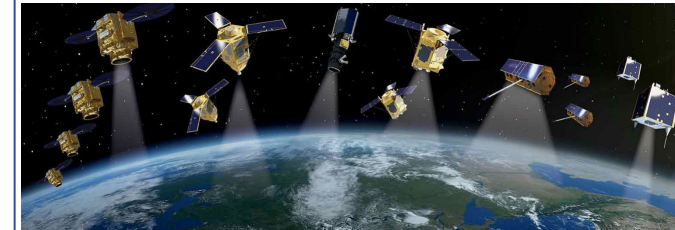
# Outline

1. Introduction: context, definitions, purpose for this presentation
2. General steps for equipment development
3. Traditional qualification methods
4. Newspace approach & validation methods
5. Summary
6. Conclusion

# Introduction: Context



NanoSat  
CubeSat



- The number of satellites is constantly increasing, and even more in the coming years



- But the size and the cost of these satellites is constantly decreasing

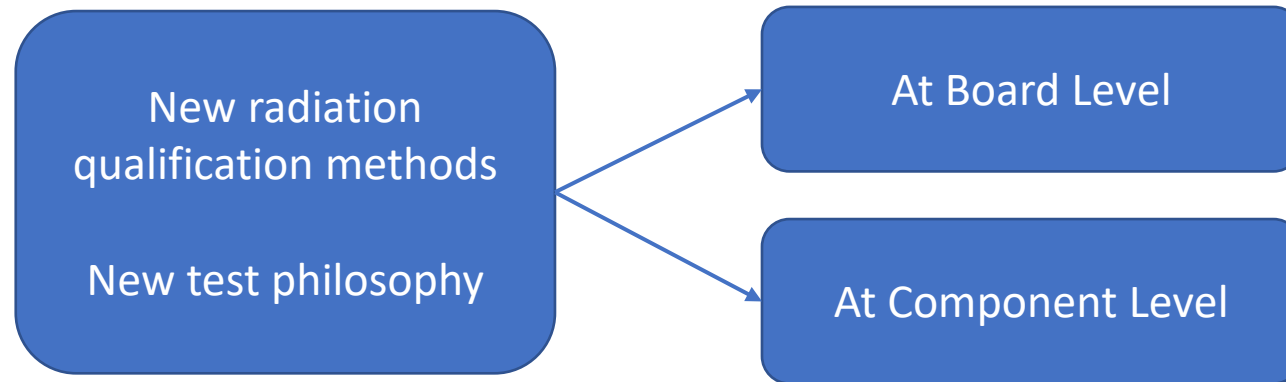
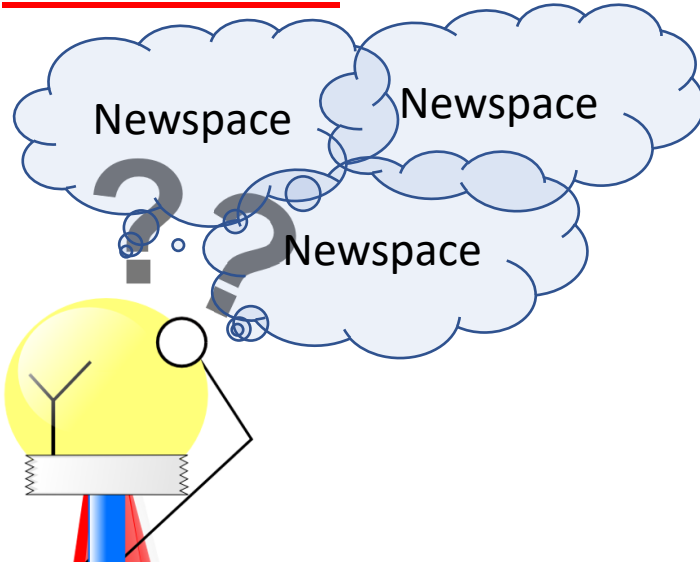


# Introduction: Definitions

## TRADITIONAL Components Qualification ... easiest to define 😊

- Fully qualified, ECSS25100, ECSS22900 (fully detailed by ESA)
- TID up to 100 krad on all parameters with a worst case for biasing conditions
- SEE with SEL free for a  $LET \geq 60 \text{ MeV.cm}^2/\text{mg}$  & a complete qualification in SET, SEU, SEFI

## NEWSPACE ... now a term used by all ... but applicable for what?



## What for the irradiation testing ?

# Introduction: purpose for this presentation

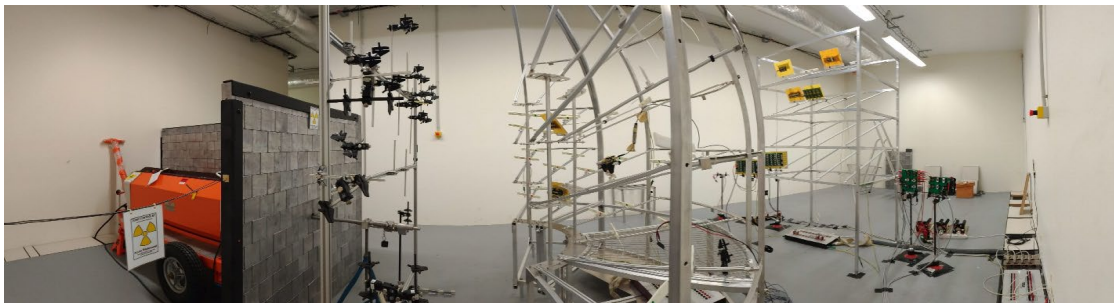
This presentation will concentrate on two types of radiation testing:

## TOTAL IONIZING DOSE

With Co60 Source  
Parametric Tests  
Biasing board during irradiation

## SINGLE EVENT EFFECTS

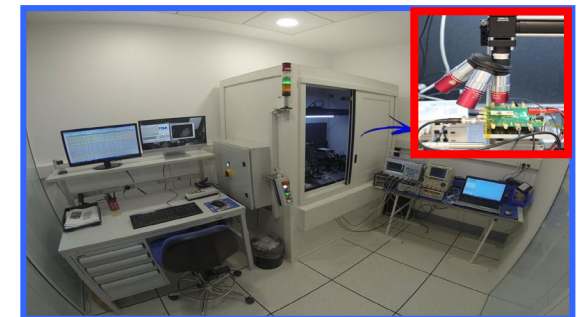
With Heavy Ions, Protons & Laser  
Functional Tests  
Latch, Transient, Upset, Burnout, ...



Gamray TRAD



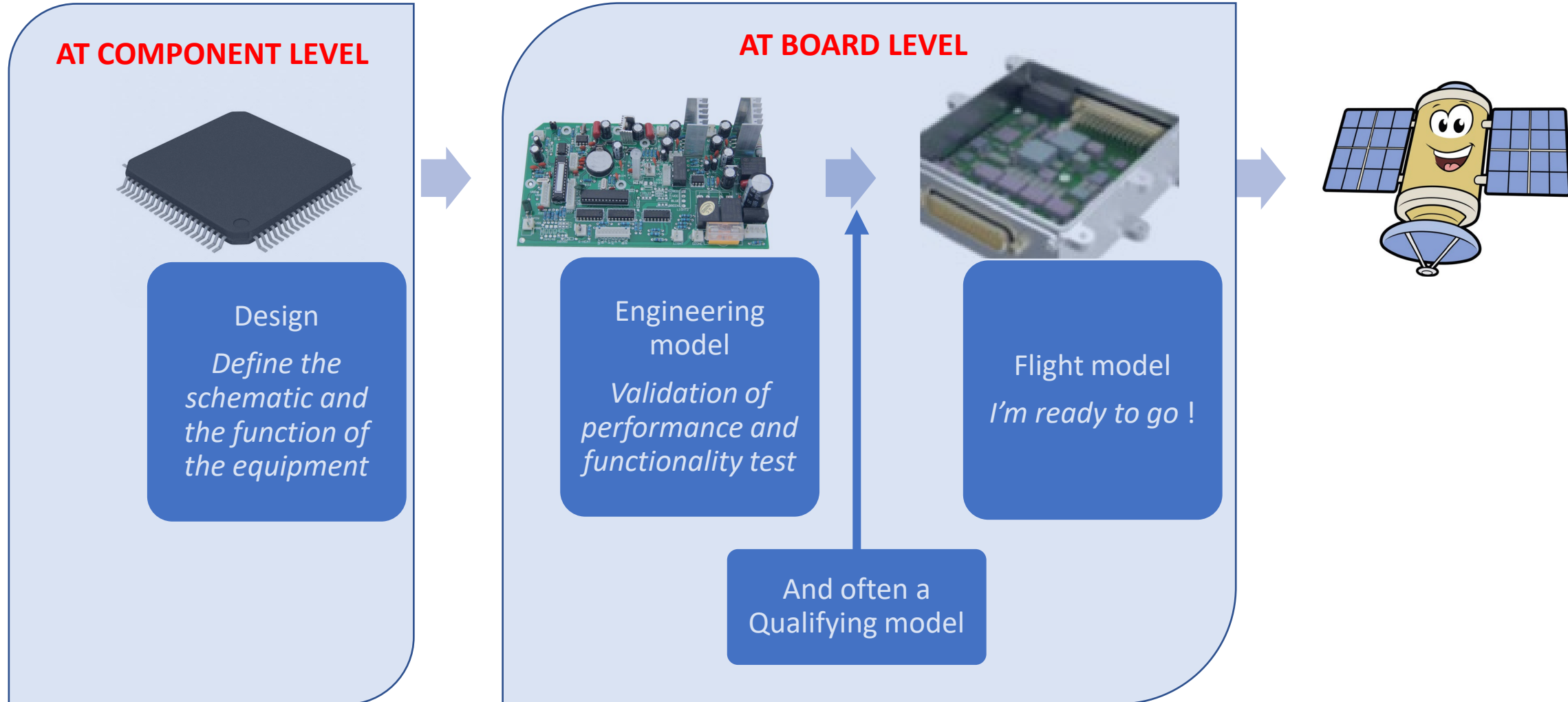
UCL Belgium



TRAD's Laser Nd:YAG

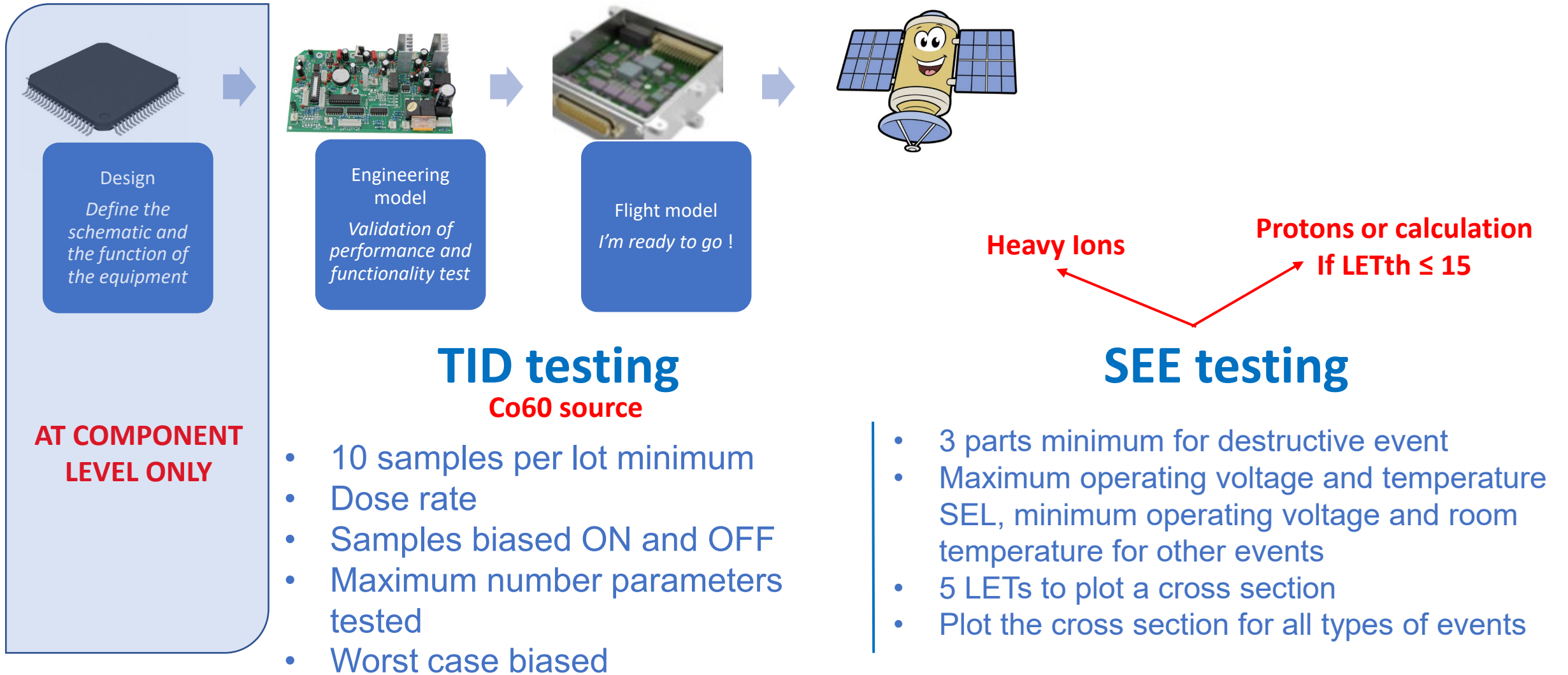
# General steps for equipment development

## At test level : Two different approaches

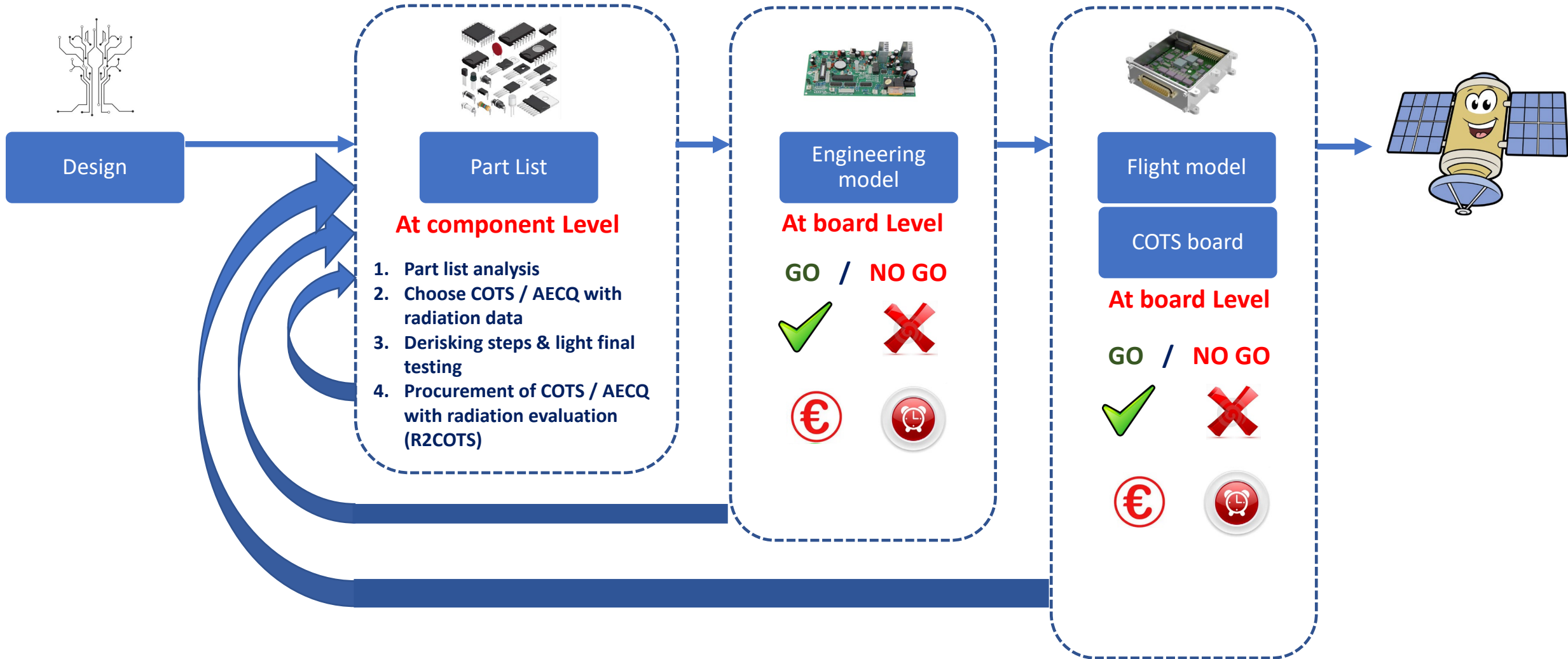




# Traditional qualification methods



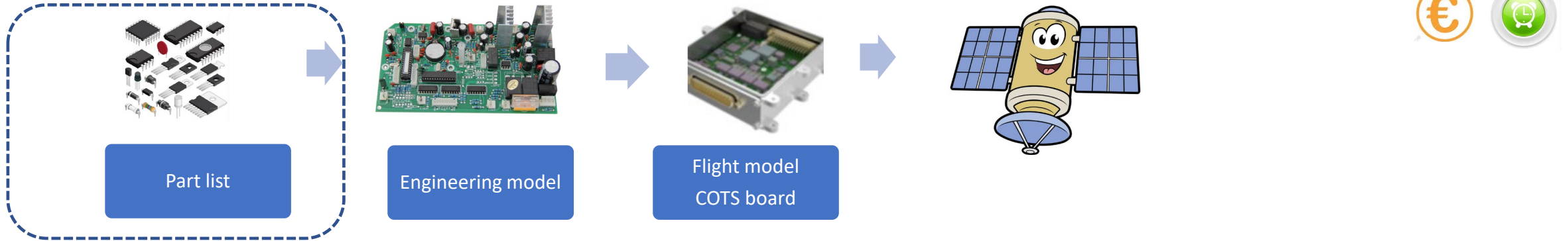
# Newspace approach & validation methods





# Newspace approach & validation methods

## AT COMPONENT LEVEL

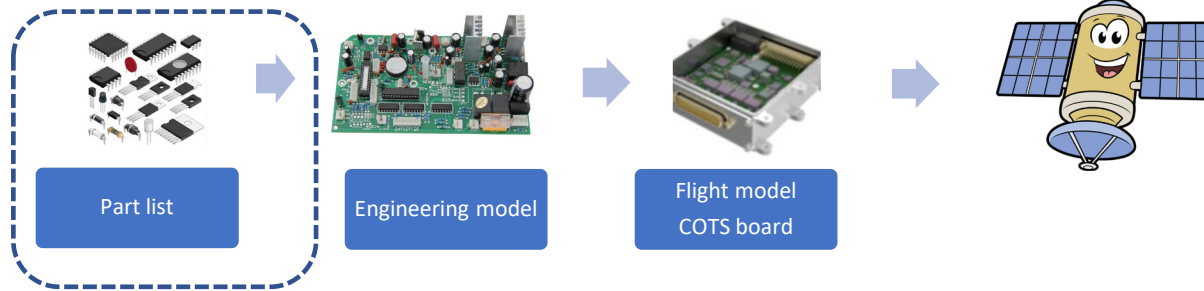


**Key point is part selection derisking: radiation prescreening of one part type + (at minimum) one backup for each reference used in the design in order to find the best candidate**

**Objective:** Reduce beam time, cost and delay to quickly find the best candidates

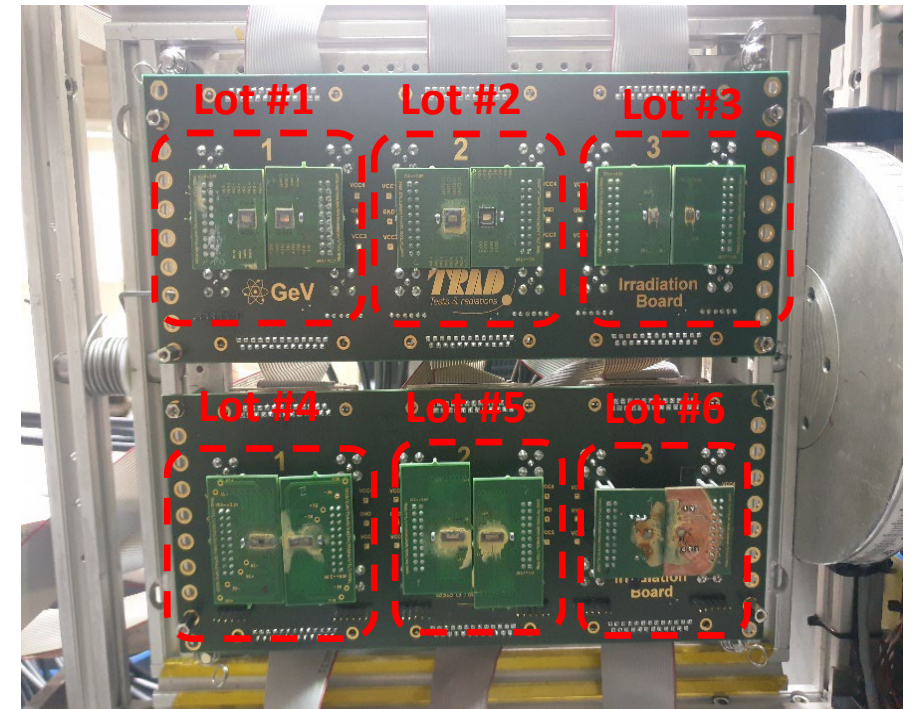
# Newspace approach & validation methods

## AT COMPONENT LEVEL



## SEE derisking advantages

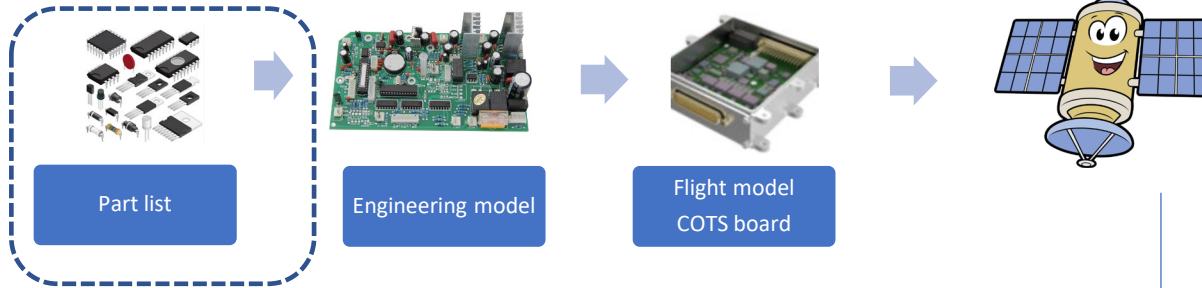
- 1 hour of beam time instead of 5 or 6 hours
- Test bench developed in a few days instead of few weeks
- It's compatible with laser and Cf242



SEE testing on vaccum chamber at UCL

# Newspace approach & validation methods

## AT COMPONENT LEVEL



## TID Derisking Testing

- Reduce time measurement
- Reduce irradiation duration
- Simplify the test bench development

|                        |                           |          |          |          |          |          |          |          |
|------------------------|---------------------------|----------|----------|----------|----------|----------|----------|----------|
| 2NXXXX                 | Irradiation test          | SOURCE   | Co60     | Location | GAMRAY   |          |          |          |
| NPN Bipolar Transistor | Irradiation steps:        |          |          |          |          |          |          |          |
| Transistor             | Accumulated dose krad(Si) | Step1    | Step2    | Step3    | Step4    | Step5    | Step6    | Step7    |
| Manufacturer           | Dose rate rad(Si)/h       | 0        | 30       | 72       | 101      |          |          |          |
| UB                     |                           | 310      | 310      | 310      | 310      |          |          |          |
|                        | Accumulated dose krad(Si) | Step8    | Step9    | Step10   | Step11   | Step12   | Step13   | Step14   |
|                        | Dose rate rad(Si)/h       |          |          |          |          |          |          |          |
|                        | Annealing test            | Period 1 | Period 2 | Period 3 | Period 4 | Period 5 | Period 6 | Period 7 |
|                        | Duration (h)              | 24       | 168      |          |          |          |          |          |
|                        | Temperature (°C)          | 25       | 100      |          |          |          |          |          |

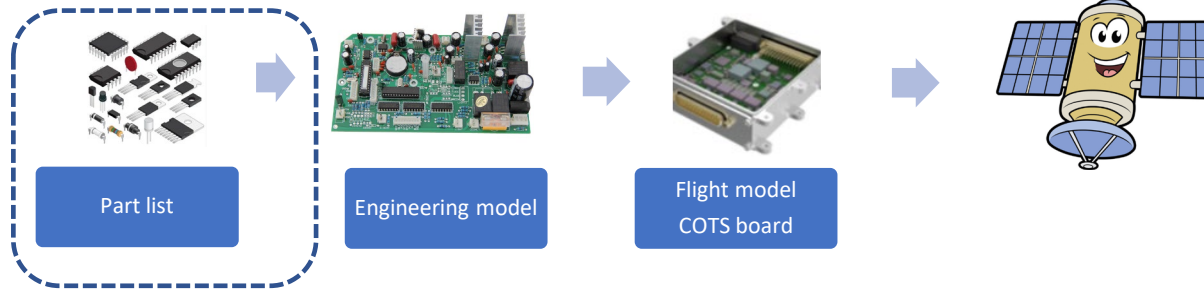
REFERENCE: This part is measured before and after irradiated components at each step.  
easured on the REFERENCE and irradiated components.  
e performed before irradiation, after each irradiation step and after each annealing period

| SYMBOLS   | TEST CONDITIONS                                    | APPLICABLE DETAIL SPECIFICATION or DATA-SHEET |     |     |      |          |  |
|-----------|--|---|-----|-----|------|----------|--|
| Symbol    | Test Conditions                                    | Min   | Typ | Max | Unit | Comments |  |
| V(BR)CEO  | IC = 10mA <sub>dc</sub>                            | 50  |     |     | V    |          |  |
| ICBO      | VCB = 60V <sub>dc</sub>                            |   |     | 10  | nA   |          |  |
| IEBO      | VEB = 4.0V <sub>dc</sub>                           |   |     | 10  | nA   |          |  |
| hFE1      | IC = 0.1mA <sub>dc</sub> , VCE = 10V <sub>dc</sub> | 50  |     |     |      |          |  |
| VCE(sat)1 | IC = 150mA <sub>dc</sub> , IB = 15mA <sub>dc</sub> |   |     | 0.3 |      |          |  |

- 6 samples per lot minimum
- High dose rate (Xray, Co60), limited n# of steps
- Reduced number of parameters tested (Eval board can be used ?)
- Simplified biasing

# Newspace approach & validation methods

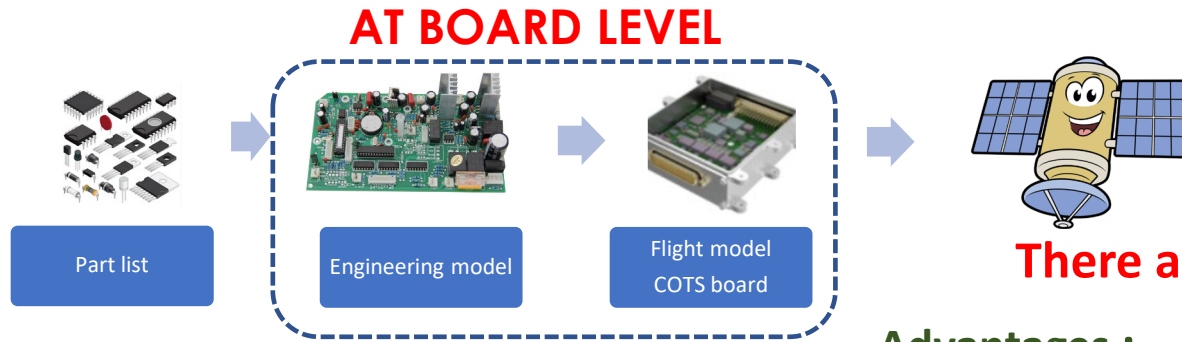
## AT COMPONENT LEVEL



SEE testing & TID testing

After the derisking a more accurate test has to be performed on the selected part types

# Newspace approach & validation methods



**There are few guidelines for board testing vs radiation\***

## Advantages :

- Board design (schematic and layer) is based on chosen reference, that fits with the final application
- Only two boards have to be tested
- The whole application is tested in one shot, allowing to save beam time

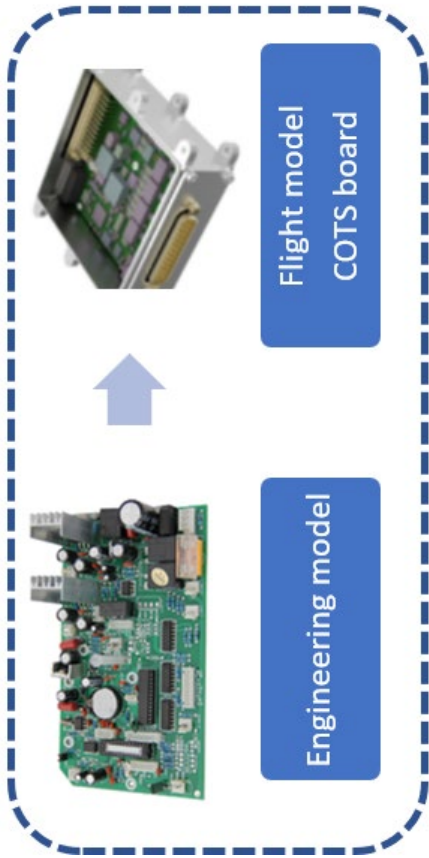
## Difficulties :

- Board design (schematic and layer) is based on chosen reference so project needs to be well advanced
- In case of significative design modification, new tests have to be performed
- Time to debug two boards can be more complex (in terms of observability and degradations)
- DUTs are validated only for one application
- In case of failure, design may need to be modified if no pin to pin alternative reference exists, and will have a huge impact in terms of planning

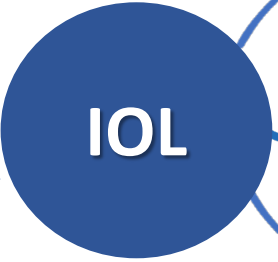
\* "Lessons and Recommendations for Board-Level Testing with Protons", SSC18-WKV-02, JPL, S. M. Guertin



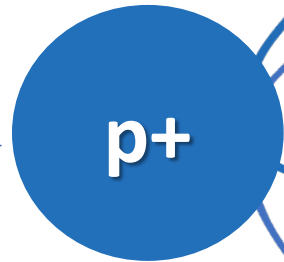
# AT BOARD LEVEL



SEE testing with



SEE testing



TID testing with



Impact of ions directly on the output



Delidded devices



SEL only on global power supply



All the board tested in one shot



Limited to an LET < 15MeV.cm<sup>2</sup>/mg



Not easy to identify the culprit if FAIL



Limited number of parameter could be monitored



Simple and rapid implementation






# Summary

|             | Traditional Space   | Newspace  |  |
|-------------|---|---|--|
| Level       | At component  | At component  | At board   |
| Advantages  | Robust product,<br>proven space-reliability, approved<br>by space industry  | good compromise between Traditional &<br>NewSpace, widely available,  | Heavy Ions : directly on the EM board<br>TID : simple & rapid implementaion  |
| Drawback    | (Very) expensive,<br>long lead time,<br>less-advanced technology  | components usable only on certain<br>missions depending on the radiation<br>results   | Heavy Ions : delidding operations &<br>SEL on the global power supplies<br>TID : monitored parameters are<br>limited (GO/NO GO test)                         |
| TID testing | 11 parts ( 5 ON + 5 OFF + 1 REF)<br>Low Dose rate $\leq 360$ rad/h<br>Worst case for biasing conditions<br>ECSS22900  | 7 parts ( 3 ON + 3 OFF + 1 REF)<br>Low Dose rate $\leq 360$ rad/h<br>Application case for biasing conditions  | 2 boards minimum   |
| SEE testing | 3 parts<br>$1^E6 \text{ \#/cm}^2.s \rightarrow \text{SEU, SET, } 25^\circ\text{C}$<br>$1^E7 \text{ \#/cm}^2.s \rightarrow \text{SEL, } 125^\circ\text{C}$<br>5 ions if sensitive<br>ECSS25100 | 2 parts<br>$1^E6 \text{ \#/cm}^2.s \rightarrow \text{SEU, SET, } 25^\circ\text{C}$<br>$1^E7 \text{ \#/cm}^2.s \rightarrow \text{SEL, Tapp}$<br>1-2 ions max | 2 boards<br>$1^E6 \text{ \#/cm}^2.s \rightarrow \text{SEU, SET, } 25^\circ\text{C}$<br>$1^E7 \text{ \#/cm}^2.s \rightarrow \text{SEL, Tapp}$<br>1-2 ions max |

# Conclusion

- For each chosen way, there is a solution !



## A little guide for users

- First : A good analysis of missions and needs will allow to choose the best solution (constraints versus environment)
- Second : COST / BUDGET analysis  $\Rightarrow$  Solution  
 Planning impact according to the chosen solution

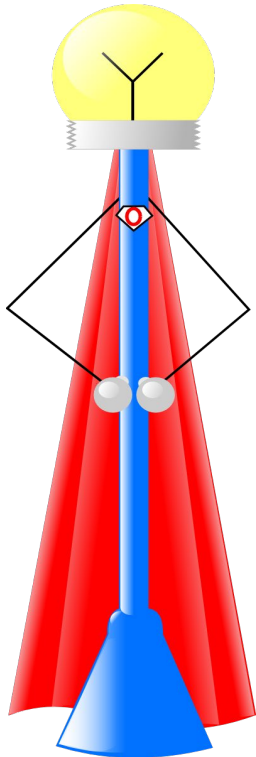
At component level  $\Rightarrow$    existing solutions as R2COTS



At board level (EM, FM, COTS board)  $\Rightarrow$  GO  $\Rightarrow$   

$\Rightarrow$  NO GO  $\Rightarrow$   

# A last word from my friend



**No magic solution but  
irradiation aspect have to  
be taken into account from  
the start of the project, you  
will save time, delay and  
money !**

# Thank you for your attention

For further information on:

[www.trad.fr](http://www.trad.fr) – [www.fastrad.net](http://www.fastrad.net)  
[www.rayxpert.com](http://www.rayxpert.com) – [www.r2cots.com](http://www.r2cots.com)



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# Introduction: Definitions

## THE SPACE MARKET IS CHANGING !!

**Almost exclusively CLASSE 1 - Hi-Rel components** : Fully qualified & screened parts

✓ Pros: Robust product, proven space-reliability, approved by space industry

✗ Cons: (Very) expensive, long lead time, less-advanced technology

**Classe 3+ → components for NEWSPACE applications**

AEC-Q qualified & Enhanced Product (EP) and / or Industrial grade T° COTS  
+ LAT (simplified if possible) & Irradiation tests



Pros: good compromise between HIREL & COTS, widely available,

Pros / Cons : Traceability

Cons: components usable only on certain missions depending on the radiation results



**Classe 3 - COTS : Commercial-off-the-shelf**

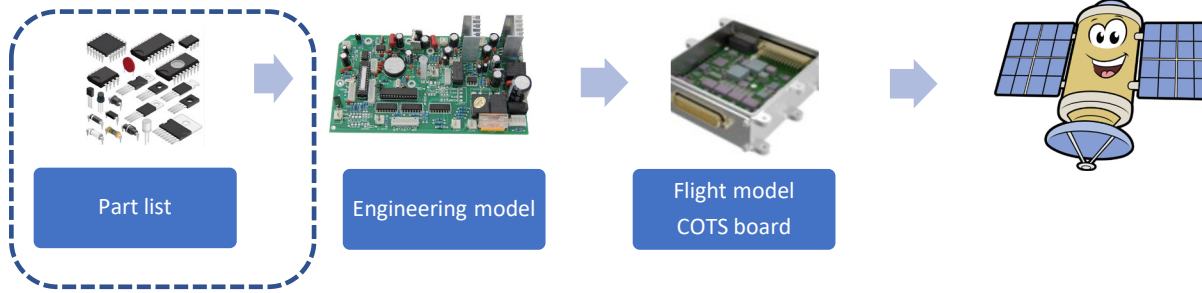
Commercial application – no part-level testing other than manufacturer control

✓ Pros: Cheap price, widely available, technologically advanced

✗ Cons: Reliability for use in space, no screening & LAT performed, end-user acceptance

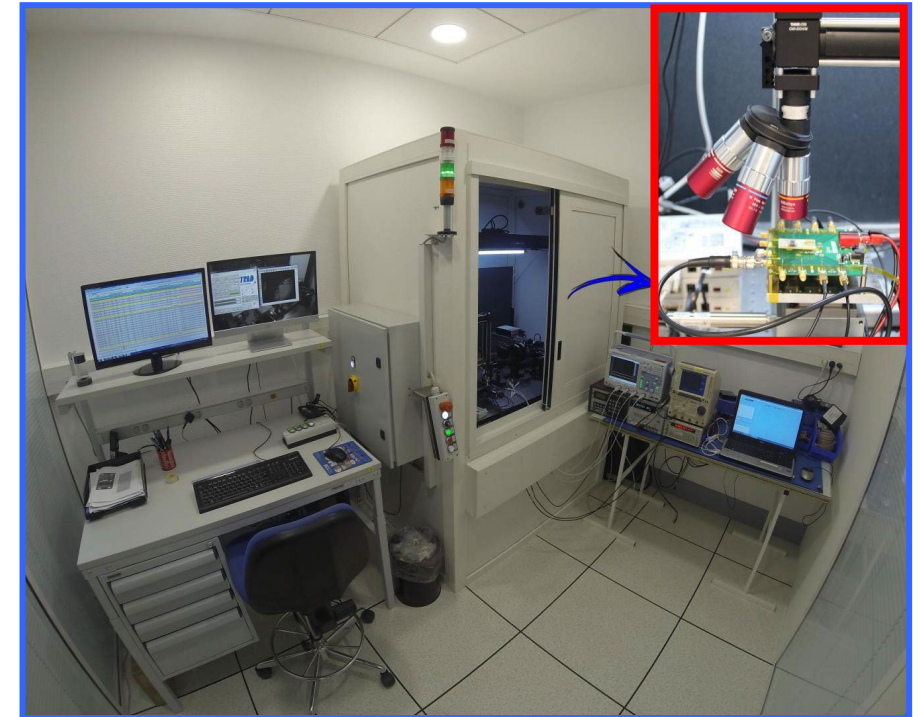
# Newspace approach & validation methods

## AT COMPONENT LEVEL



SEE derisking with laser or Cf242

- Can detect if part show sensitivity to SEL and directly remove this part
- Much less expensive than heavy ion/proton tests
- Laser can also be used for test at board level



TRAD's Laser Nd:YAG with wavelength 1064nm